

Part Number: 1051330011

Product Description: Micro-USB B Receptacle, Vertical, Surface Mount, 6.70mm Height,

2.30mm Solder Tabs, Lead-Free

Series Number: 105133

Status: Active

Product Category: I/O Connectors



Documents & Resources

Drawings

<u>Drawing 1051330011_sd.pdf</u> Packaging Design Drawing PK-105133-001-001.pdf

3D Models and Design Files3D Model 1051330011_stp.zip

Specifications

Product Specification PS-105133-001-001.pdf

Product Environment Compliance

Compliance

GADSL/IMDS	Not Relevant
China RoHS	@
EU ELV	Not Relevant
Low-Halogen Status	Low-Halogen per IEC 61249-2-21
REACH SVHC	Not Contained per D(2023)3788-DC (14 Jun 2023)
EU RoHS	Compliant per EU 2015/863

Multiple Part Product Compliance Statements

- Eu RoHS
- REACH SVHC
- Low-Halogen

Multiple Part Industry Compliance Documents

- IPC 1752A Class C
- IPC 1752A Class D

- Molex Product Compliance Declaration
- IEC-62474
- chemSHERPA (xml)

EU RoHS Certificate of Compliance

Part Details

General

Status	Active
Category	I/O Connectors
Series	105133
Description	Micro-USB B Receptacle, Vertical, Surface Mount, 6.70mm Height, 2.30mm Solder Tabs, Lead-Free
Application	Wire-to-Board
Comments	Signal contacts 1.0A, Power contacts 1.8A
Component Type	Receptacle
Product Family	USB Connectors: USB Type-A, USB Type-B, and USB Type-C Plugs and Receptacles
Product Name	USB
Standard	USB 2.0
Туре	Micro-B
UPC	887191097947

Agency

UL	E107635
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Electrical

Current - Maximum per Contact	1.8A, 1.0A
Grounding to Panel	Yes
Shield Type	Full Shield
Shielded	Yes
Voltage - Maximum	30V AC (RMS)

Physical

Circuits (Loaded)	5
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Circuits (maximum)	5
Color - Resin	Black
Durability (mating cycles max)	10000
Flammability	94V-0
Gender	Female
Keying to Mating Part	Yes
Lock to Mating Part	No
Material - Metal	Copper Alloy
Material - Plating Mating	Gold over Palladium Nickel
Material - Plating Termination	Gold
Material - Resin	High Temperature Thermoplastic
Mounting Style	Vertical
Net Weight	0.360/g
Number of Rows	1
Orientation	Vertical
Packaging Type	Embossed Tape on Reel
Panel Mount	No
PCB Retention	None
PCB Thickness - Recommended	1.60mm
Pitch - Mating Interface	0.65mm
Pitch - Termination Interface	0.65mm
Polarized to Mating Part	Yes
Polarized to PCB	Yes
Ports	1
Temperature Range - Operating	-30° to +85°C
Termination Interface Style	Surface Mount
Waterproof / Dustproof	No

Solder Process Data

Max-Duration	10
Lead-Free Process Capability	REFLOW
Max-Cycle	1
Max-Temp	260

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